

INFN VTH COMMITTEE



NEW PROJECT **[NUCLEAAR]** [LNF+RM1]

NEW COATINGS FOR CHALLENGING APPLICATIONS IN ACCELERATORS [2019/20]

National coordinator A. Marcelli (LNF)

RM1 coordinator S. Lupi (Sapienza)

2 year project

Co-funded by MAECI and Osaka university (Japan)

Italian collaborations: CNR/ISM

Potential international collaborations:

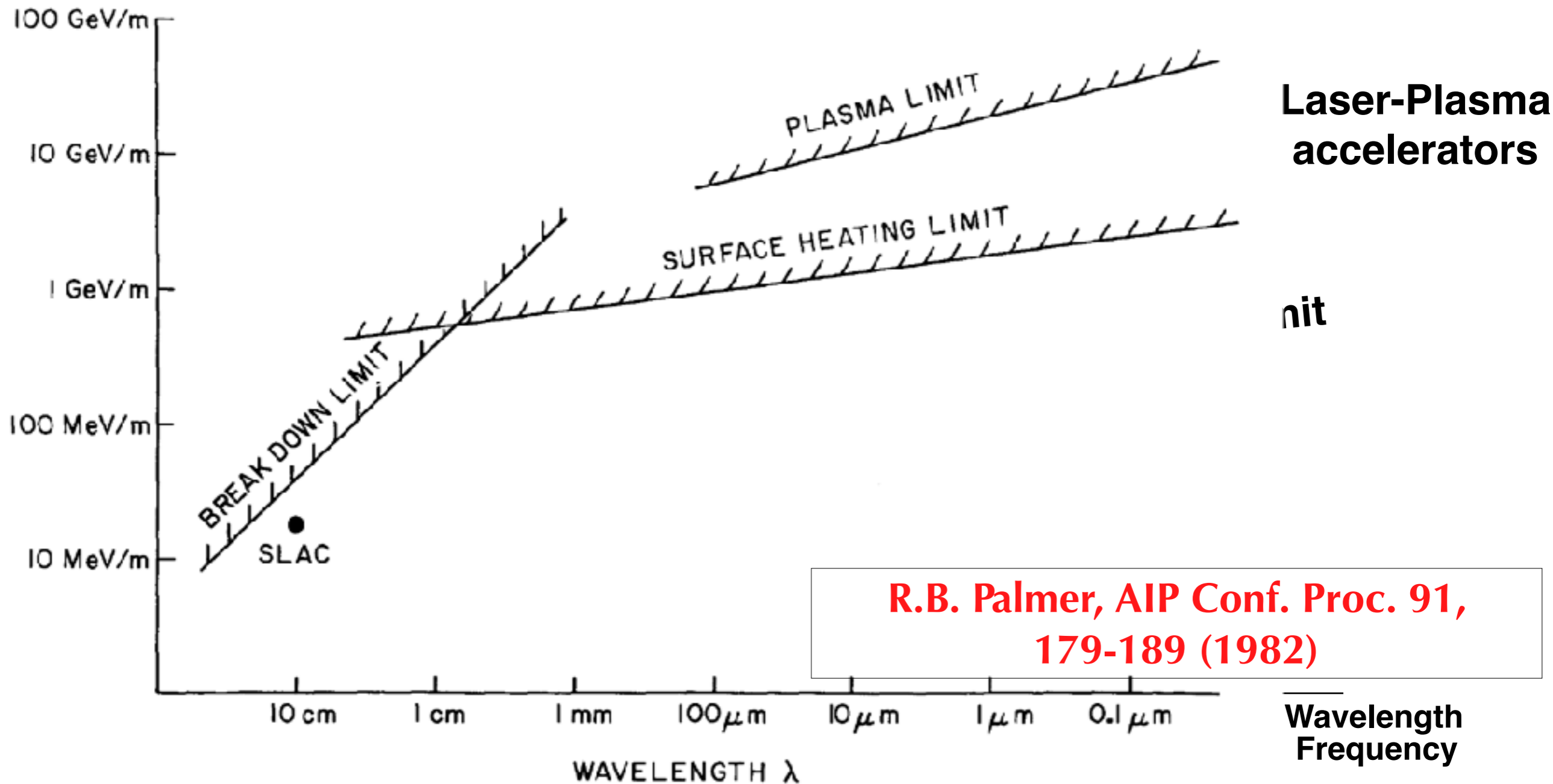
Diamond (UK)/SLAC (USA)/USTC (P.R.China) /Dragon Thin film Laboratory (LV)



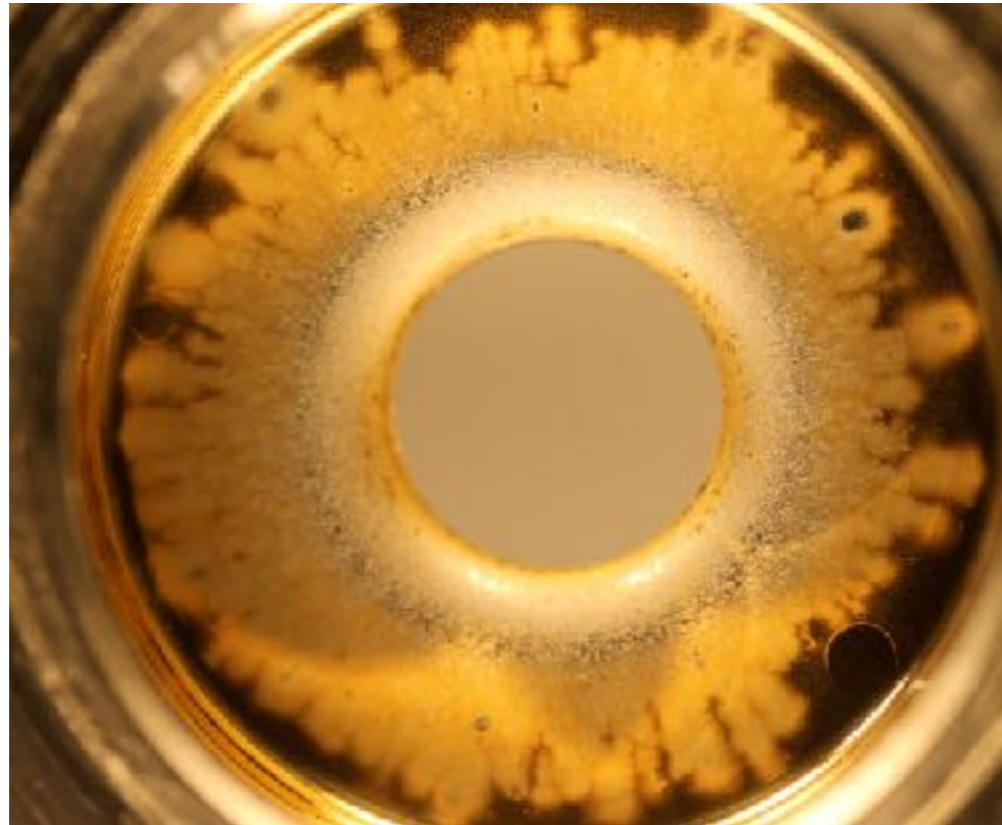
Gruppo V – Frascati 2 luglio 2018

Accelerating field limits

Electric field gradient



Autopsy of an electroformed Au-Ni structure



High gradient side of
Center cell



High gradient side of
End cell

**Au coating is removed from the high-electric field area
by multiple breakdowns**

Next Generation High Brightness Electron Beams From Ultra-High Field Cryogenic Radiofrequency Photocathode Sources

J.B. Rosenzweig¹, A. Cahill¹, V. Dolgashev², C. Emma¹, A. Fukusawa¹, R. Li², C. Limborg², J. Maxson¹, P. Musumeci¹, A. Nause¹, R. Pakter¹, R. Pompili³, R. Roussel¹, B. Spataro³, and S. Tantawi²

¹*Department of Physics and Astronomy, University of California, Los Angeles*

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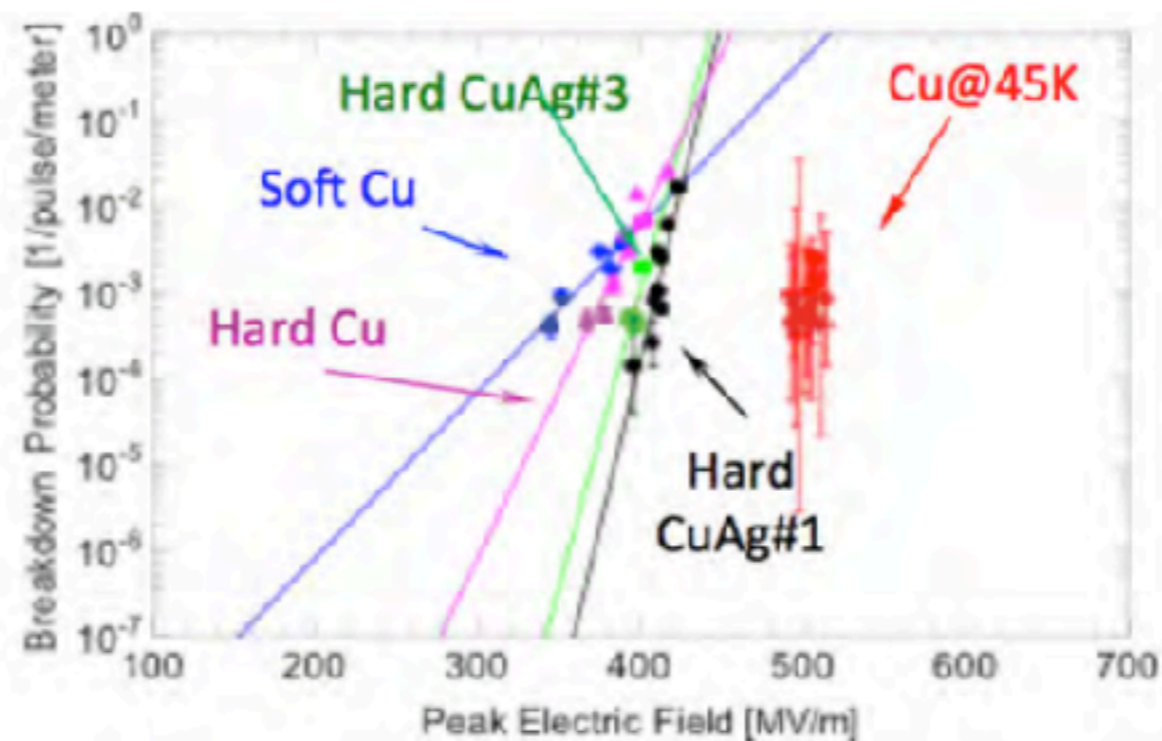
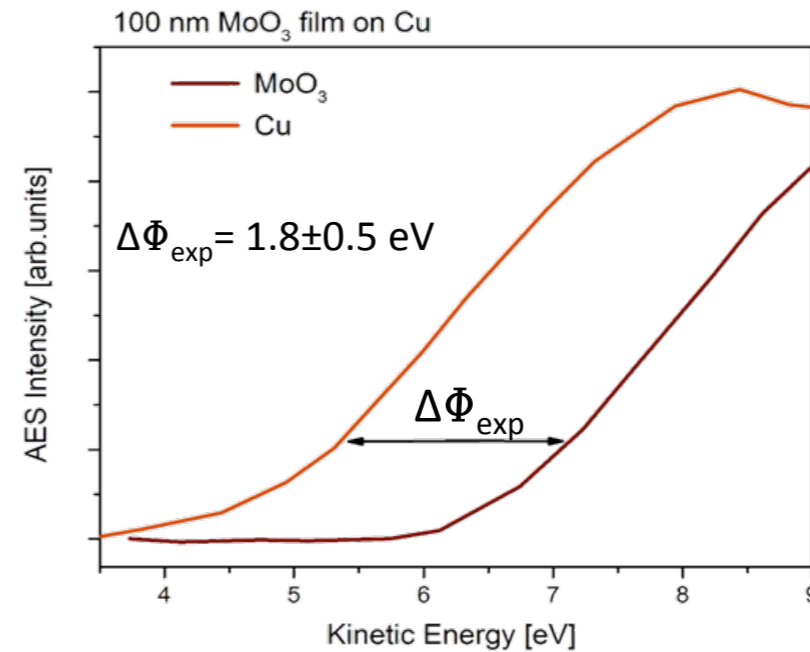
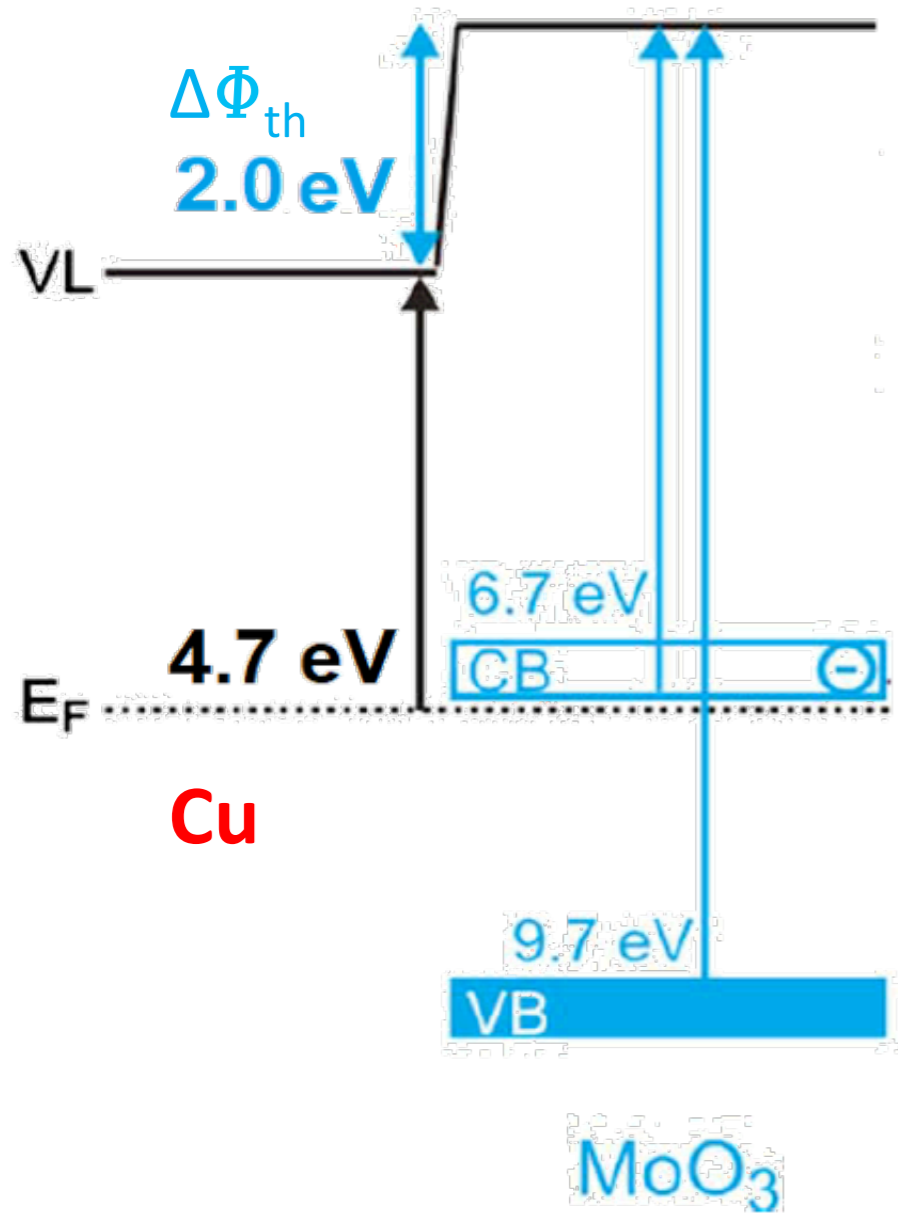


Figure 2. Breakdown probability as a function of peak electric field in single cell X-band accelerating structure tests. The introduction of a harder alloy improves the breakdown as predicted; the effect of operation at 45 deg K is more dramatic, permitting surface electric fields of 500 MV/m.

Enhancement of the WF



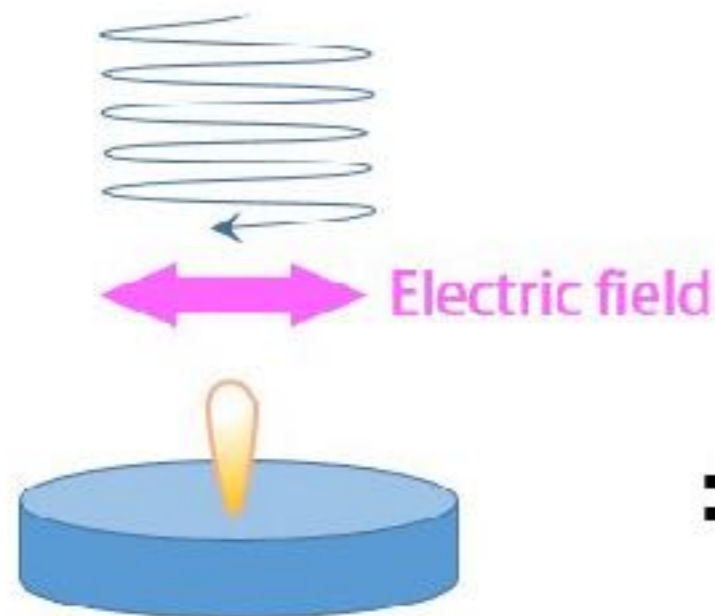
Experimental work functions for a thin film characterised with the Auger spectroscopy. Measurements were performed at normal incidence with an electron beam at 1 keV. The measurements of this MoO₃ films show a WF ~1.8 eV higher than Cu, in agreement with the expected enhancement of ~2 eV (see left).

THz nonlinear excitation

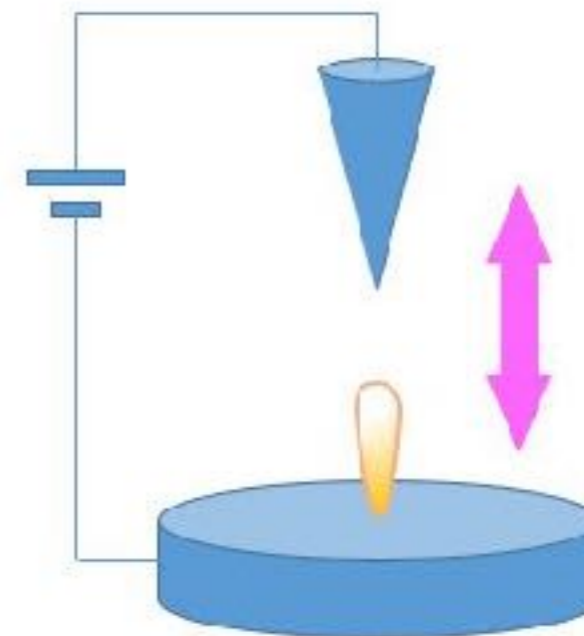
High electric field

THz FEL excitation (AC)

Discharge (DC)



≠



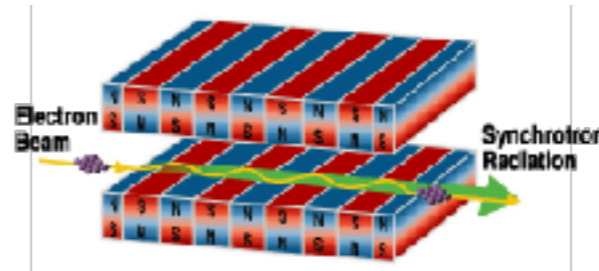
kinetic energy
⇒ *potential energy*
⇒ *photoelectron*

field electron emission (breakdown)

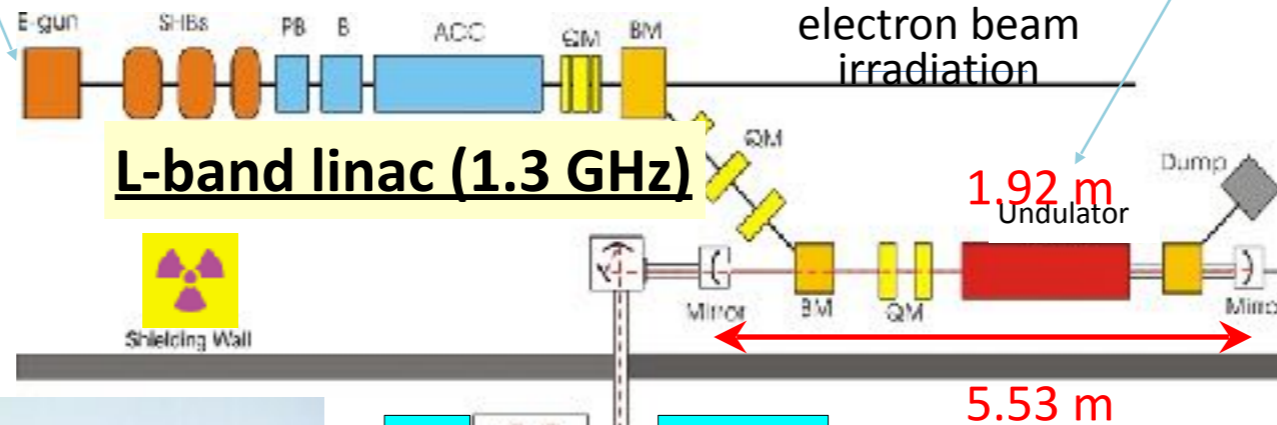
ISIS@OSAKA



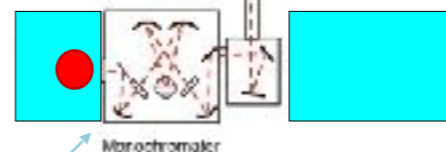
Electron gun



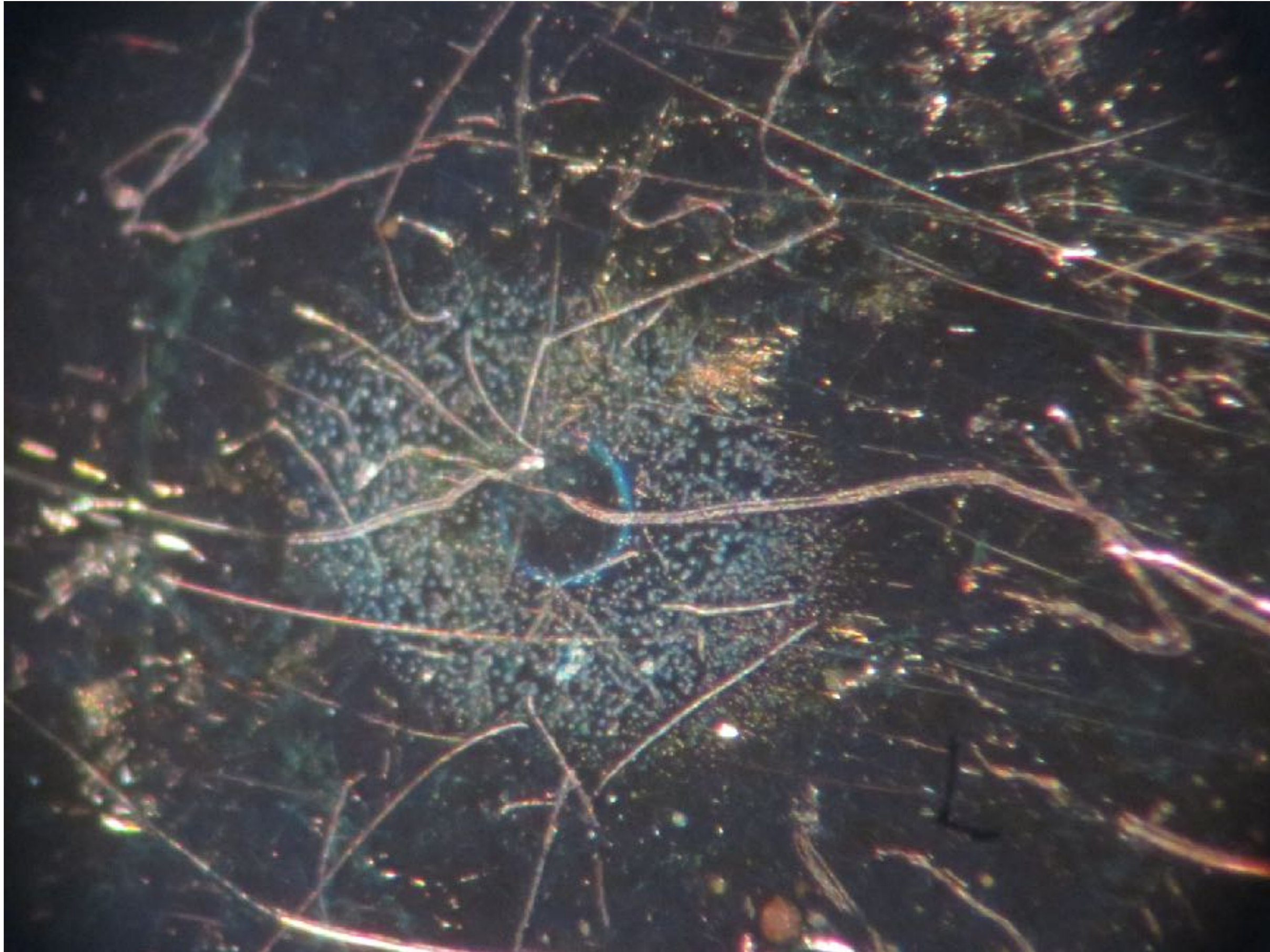
Buncher and accelerator

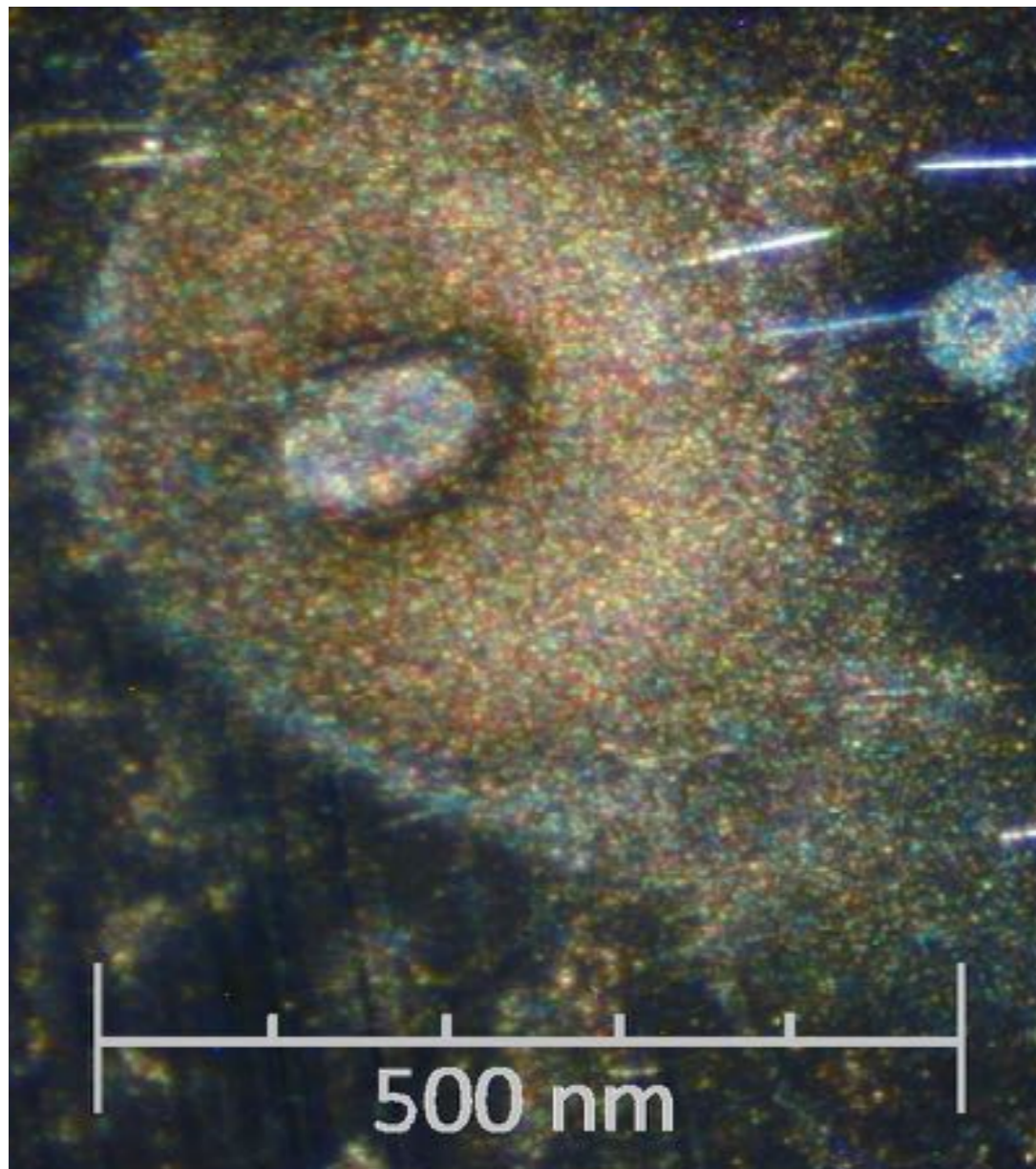


Shielding wall



Experimental area





~10 GV/m

Irradiation no. 10

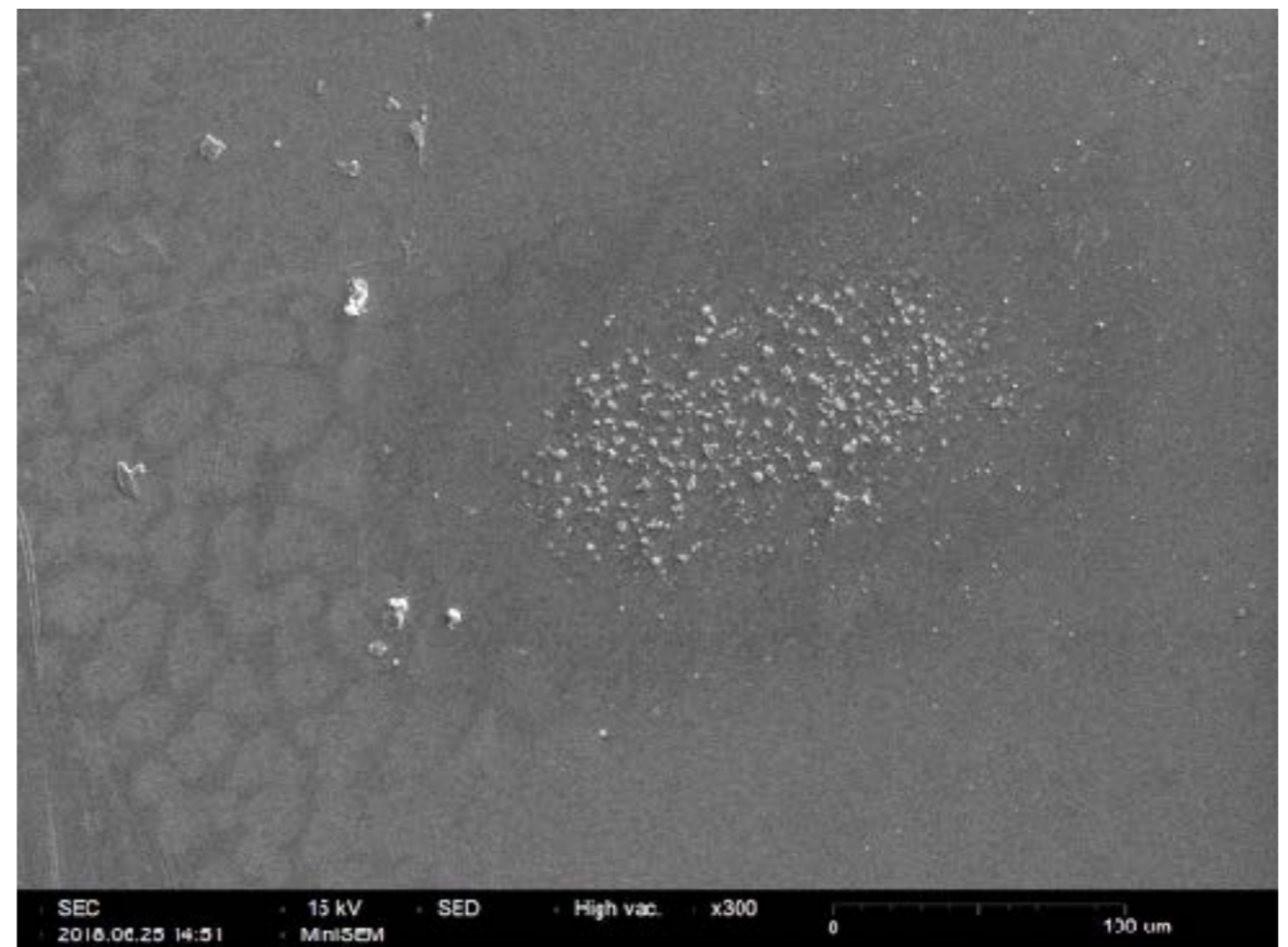
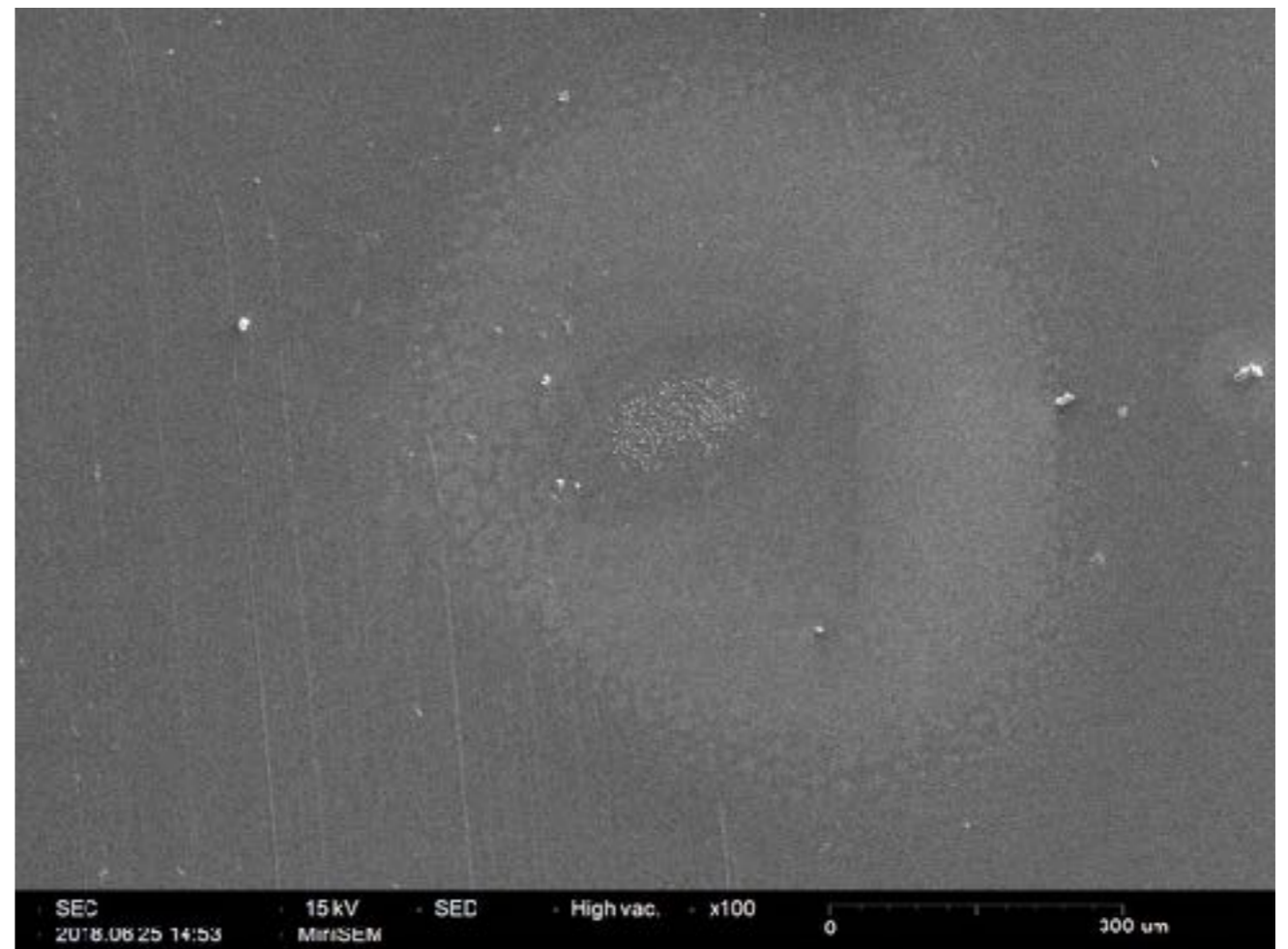
Sample: copper

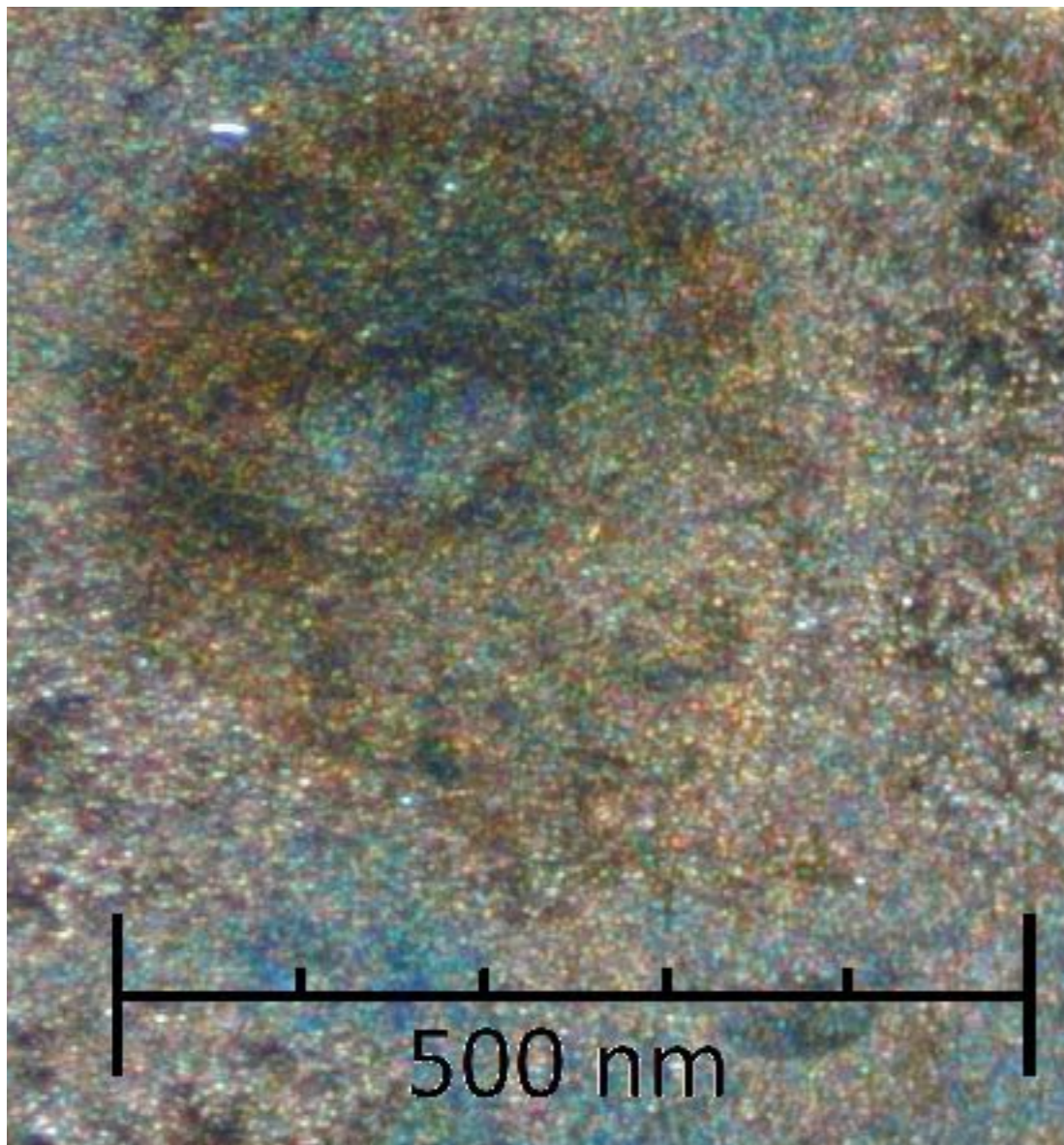
shots: 5000

Angle: 45°

Center diameter: ~180 μm

Total spot diameter: ~400 μm





~10 GV/m

Irradiation no. 10

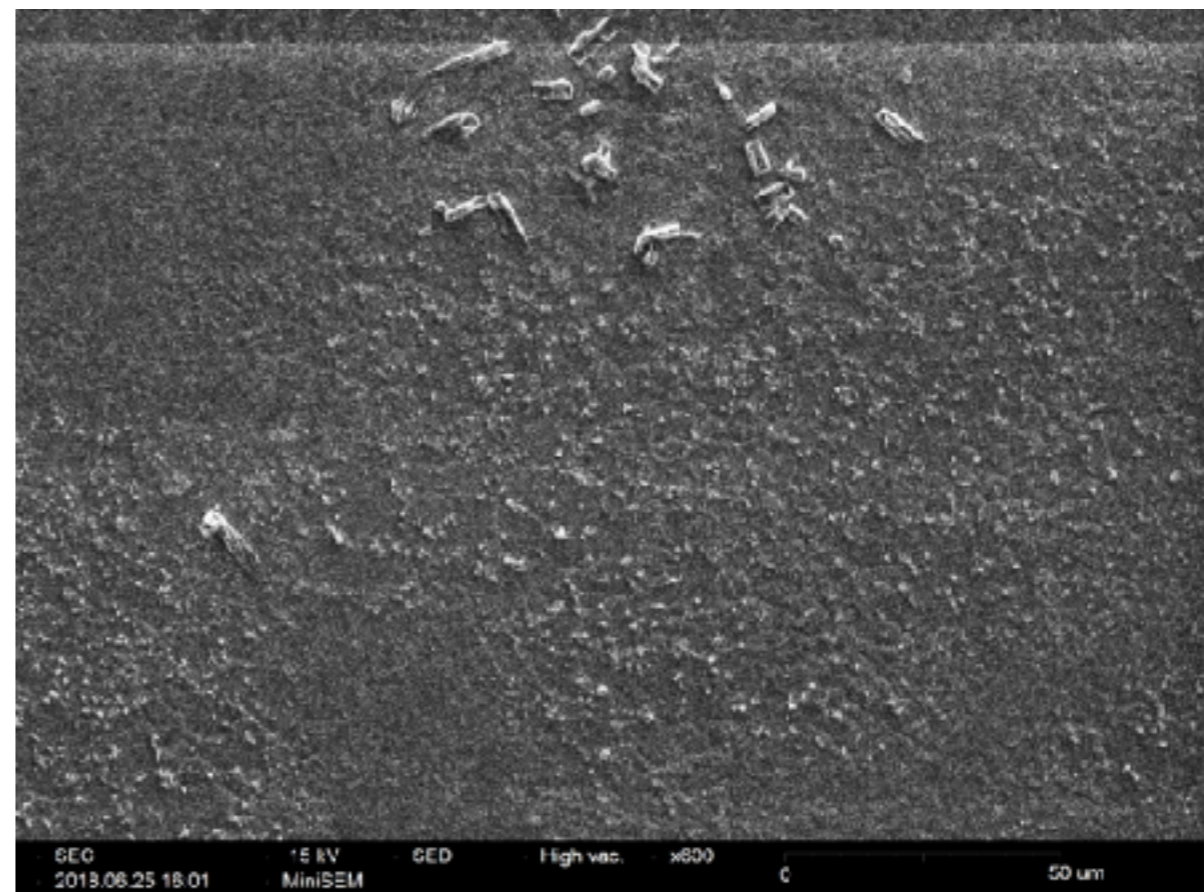
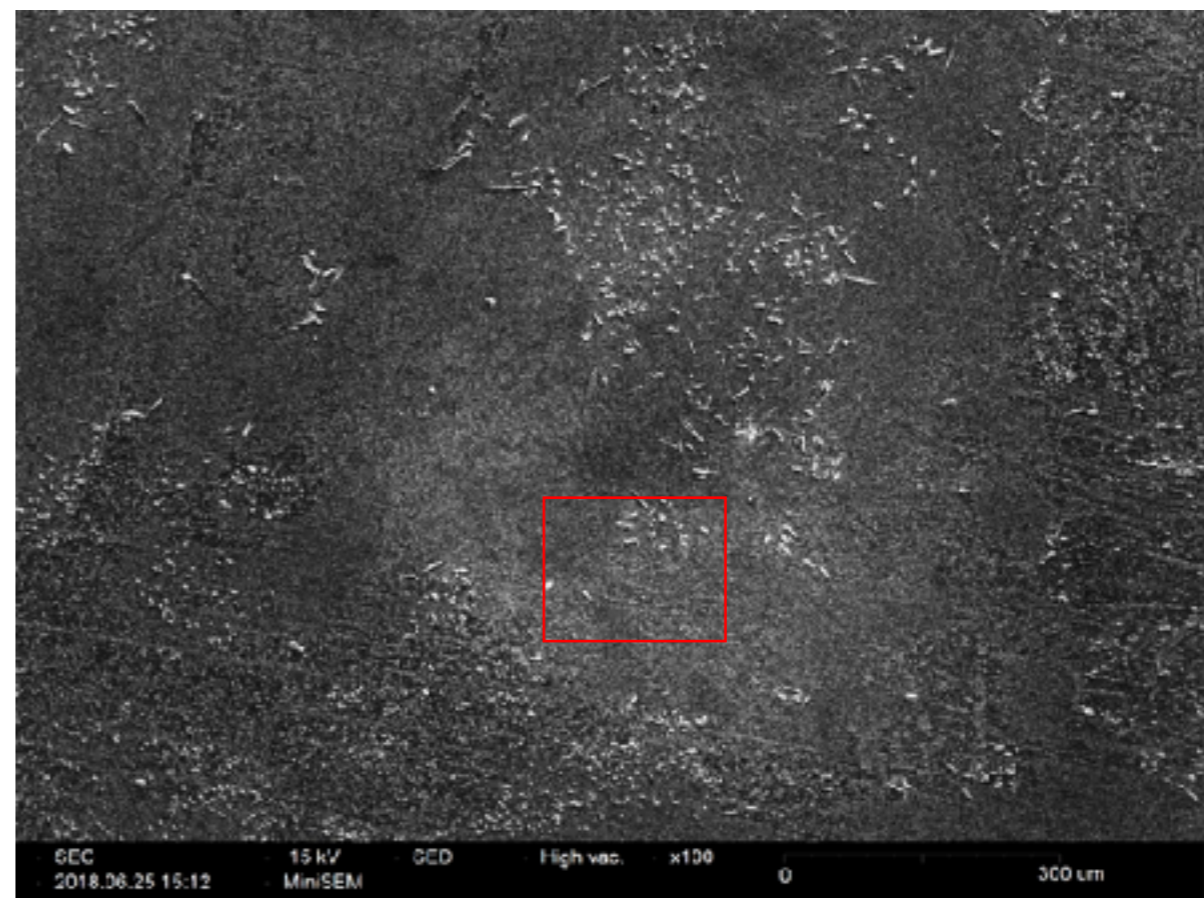
Sample: Annealed MoO₃

shots: 5000

Angle: 45°

Center diameter: ~150 μm

Total spot diameter: ~370 μm



HIGHLIGHTS

- ▶ To improve the performance of RF device we propose to investigate the possibility to coat Cu materials with transition metal (TM) and TM oxides. Depositions of Mo and Mo oxides have been already obtained under vacuum and structural and electronic characterisation have been obtained with excellent results.
- ▶ The method we propose is a promising approach to obtain homogeneous coatings suitable to increase performances of RF cavities working at high frequencies. We combined FIB imaging to visualise at high spatial resolution the morphology of the films and to accurately measure the thickness. Transport experiments have been performed to measure the resistivity, while XRD and XAS techniques were used to evaluate the degree of crystallinity, identify different ordered phases and probe the local structure and their electronic properties.
- ▶ Mo and Mo oxides have been already characterised in term of conductivity properties for both ultra thin and thick films and in term of work function (WF). As an example, polycrystalline MoO₃, prepared by vacuum sublimation of MoO₃ exhibits a work function between 6.8-6.9 eV much higher than polycrystalline Cu whose WF is ~4.6 eV.
- ▶ In this project we plan to improve the adhesion and the harness characteristic of these films and apply this new technology to dedicated RF devices to be manufactured at LNF.

ACTIVITIES

- ▶ Preparation of thin and thick films on copper with TMs characterised by: Low electron field emission, high work function, high conductivity and high mechanical resistance
- ▶ Preparation of thin and thick TM/TM oxides films on curved surfaces of copper
- ▶ Damage (breakdown) tests at high electric field using FEL radiation up to several GV/m
- ▶ Manufacture of a small prototype of a RF cavity with a coating made by TMs or TMs oxides

NUCLEAAR 2019/20

LNF + RM1 FTE: 2.6

INFN/LNF FTE: 1.4

A. Marcelli (Coord. Naz.)	30 %	Primo Ricer.
G. Della Ventura	40 %	Associato
S. Macis	50 %	Associato
J. Scifo	20 %	Fellow

B. Spataro		Associato senior
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INFN/RM1 FTE: 1.2

M. Petrarca (Coord. Loc.)	20 %	Associato
S. Lupi	20 %	Associato
S. Sarti	20 %	Associato
A. D'Arco	60 %	Associato